MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V	
Average Rectified Forward Current $T_L = 120^{\circ}C$ $T_L = 110^{\circ}C$	I _{F(AV)}	1.0 2.0	А	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	40	Α	
Operating Junction Temperature	TJ	-65 to +125	°C	

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead	$\Psi_{\sf JL}$	12	°C/W
Thermal Resistance, Junction-to-Ambient (T _A = 25°C, Min Pad, 1 oz copper) Junction-to-Ambient (T _A = 25°C, 1" Pad, 1 oz copper)	$R_{ hetaJA}$	228.8 71.3	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 1) $ \begin{aligned} &(i_F=1.0 \text{ A, } T_J=25^\circ\text{C}) \\ &(i_F=2.0 \text{ A, } T_J=25^\circ\text{C}) \end{aligned} $	V _F	0.395 0.445	V
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 25$ °C) (Rated dc Voltage, $T_J = 100$ °C)	I _R	1.0 10	mA

^{1.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2%.

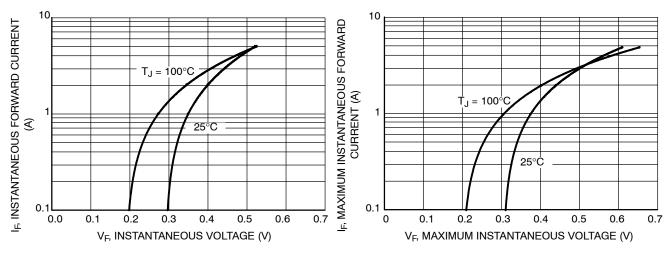


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

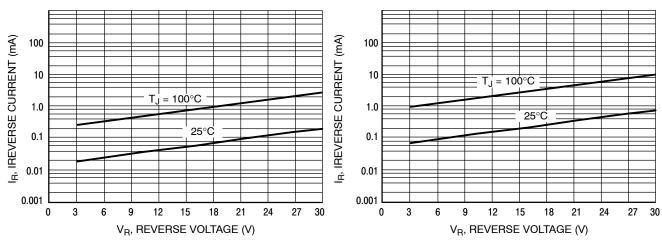


Figure 3. Typical Reverse Leakage Current

Figure 4. Typical Maximum Reverse Leakage
Curent

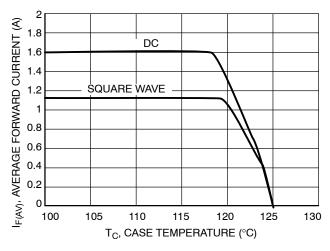


Figure 5. Current Derating (Case)

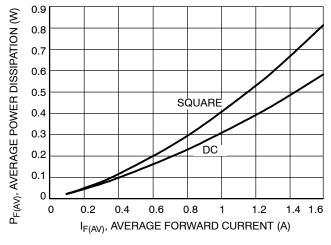


Figure 6. Typical Power Dissipation

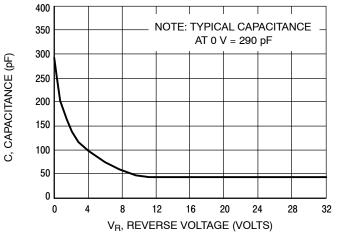


Figure 7. Typical Capacitance

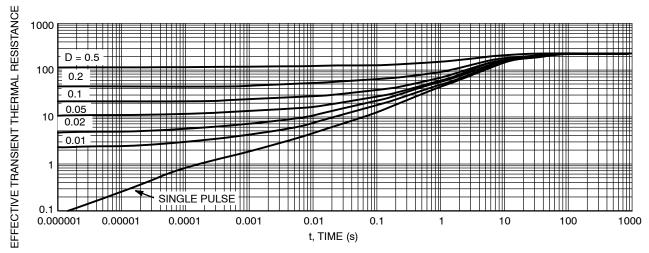


Figure 8. Thermal Response, Min Pad

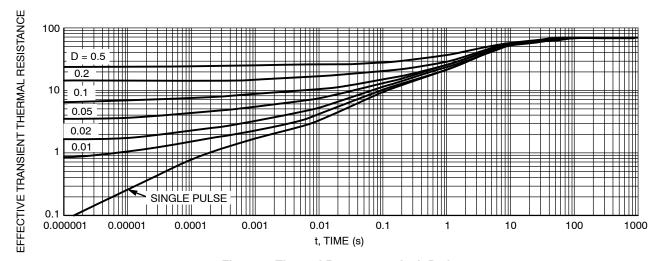


Figure 9. Thermal Response, 1 Inch Pad

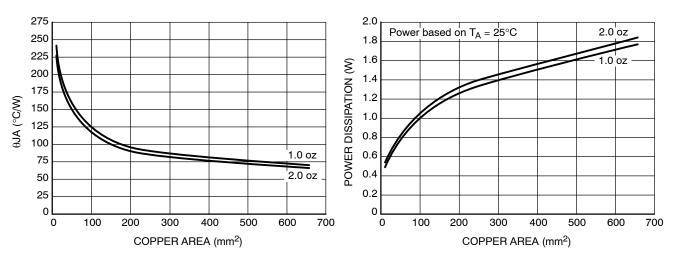
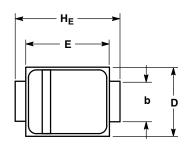


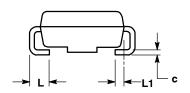
Figure 10. Thermal Resistance vs. Copper Area

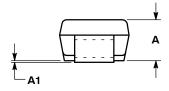
Figure 11. Power Dissipation vs. Copper Area

PACKAGE DIMENSIONS

SMB CASE 403A-03 **ISSUE G**



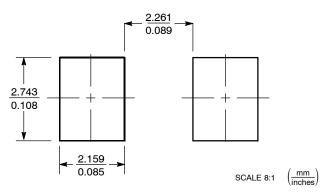




- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	MOM	MAX
Α	1.90	2.13	2.45	0.075	0.084	0.096
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.96	2.03	2.20	0.077	0.080	0.087
С	0.15	0.23	0.31	0.006	0.009	0.012
D	3.30	3.56	3.95	0.130	0.140	0.156
Е	4.06	4.32	4.60	0.160	0.170	0.181
HE	5.21	5.44	5.60	0.205	0.214	0.220
L	0.76	1.02	1.60	0.030	0.040	0.063
L1	0.51 REF			0.020 REF		

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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